SN74AS298A **QUADRUPLE 2-INPUT MULTIPLEXER** WITH STORAGE

SDAS219B - DECEMBER 1983 - REVISED DECEMBER 1994

16 V_{CC}

15 QA

14 🛛 Q_B

13 Q_C

12 QD

11 CLK

10 WS

9 C1

D OR N PACKAGE

(TOP VIEW)

B2 🛛

A2 2

А1 🛛 з

B1 🛛 4

C2 🛛 5

D1 **1**7

6

D2 🛛

GND 🛛 8

- Selects One of Two 4-Bit Data Sources and Synchronously Stores Data With System Clock
- **Applications:**
 - Dual Source for Operands and Constants in Arithmetic Processor; Can Release **Processor Register Files for Acquiring** New Data
 - Implements Separate Registers Capable of Parallel Exchange of Contents, Yet **Retains External Load Capability**
 - Has Universal-Type Register for Implementing Various Shift Patterns, Including Compound Left-Right Capability
- Package Options Include Plastic Small-Outline (D) Packages and Standard Plastic (N) 300-mil DIPs

description

The SN74AS298A is a quadruple 2-input multiplexer with storage that provides essentially the equivalent functional capabilities of two separate MSI functions (SN74AS157 and 'AS175A) in a 16-pin package.

When the word-select (WS) input is low, word 1 (A1, B1, C1, D1) is applied to the flip-flops. A high input to WS causes the selection of word 2 (A2, B2, C2, D2). The selected word is clocked to the output terminals on the negative-going edge of the clock pulse.

The SN74AS298A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE							
INP	UTS						
WS	CLK	QA	QB	QC	QD		
L	\downarrow	a1	b1	c1	d1		
н	\downarrow	a2	b2	c2	d2		
Х	Н	Q _{A0}	Q _{B0}	Q _{C0}	Q _{D0}		
±							

ELINCTION TABLE

† a1, a2, etc. = the level of steady-state input at A1, A2, etc.

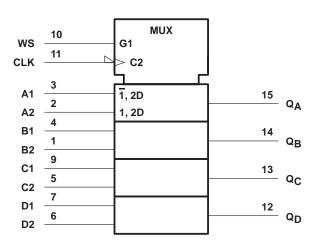
QA0, QB0, etc. = the level of QA, QB, etc. entered on the most recent \downarrow transition of CLK



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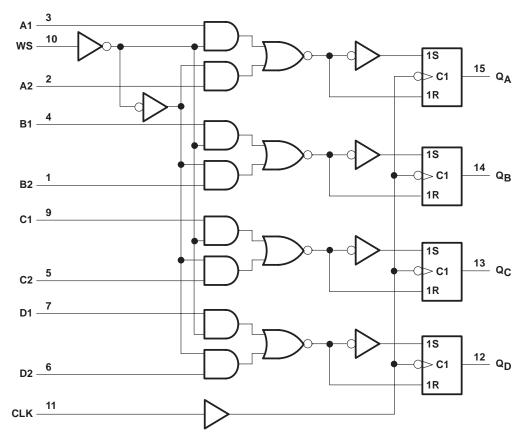
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	7 V
Input voltage, V ₁	7 V
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range	°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
ЮН	High-level output current			-2	mA
IOL	Low-level output current			20	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CC	ONDITIONS	MIN TYP‡	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lı = –18 mA		-1.2	V
VOH		V_{CC} = 4.5 V to 5.5 V,	$I_{OH} = -2 \text{ mA}$	V _{CC} -2		V
VOL		V _{CC} = 4.5 V,	I _{OL} = 20 mA	0.35	0.5	V
Ιį		V _{CC} = 5.5 V,	V _I = 7 V		0.1	mA
ΊΗ	WS	V _{CC} = 5.5 V,	V ₁ = 2.7 V		40	μA
	All others				20	
1	WS	V _{CC} = 5.5 V,	V _I = 0.4 V		-0.75	mA
۱Ľ	All others				-0.5	
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-30	-112	mA
Іссн		$V_{CC} = 5.5 V$		21	33	mA
ICCL		$V_{CC} = 5.5 V$		22	36	mA

[‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
fclock	f _{clock} Clock frequency		0	62	MHz
tw	Pulse duration, CLK high or low		8		ns
t _{SU} Setup tir	Setup time before CLK \downarrow	Data	4.5		ns
		WS	13		115
th	Hold time after CLK↓	Data	3.5		200
		WS	1		ns



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	МАХ	UNIT
fmax			62		MHz
^t PLH	CLK	Q	2	9	
^t PHL	CLK		1	11	ns

APPLICATION INFORMATION

This versatile multiplexer can be connected to operate as a shift register that can shift n places in a single clock pulse.

Figure 1 illustrates a BCD shift register that shifts an entire 4-bit BCD digit in one clock pulse.
Parallel Load

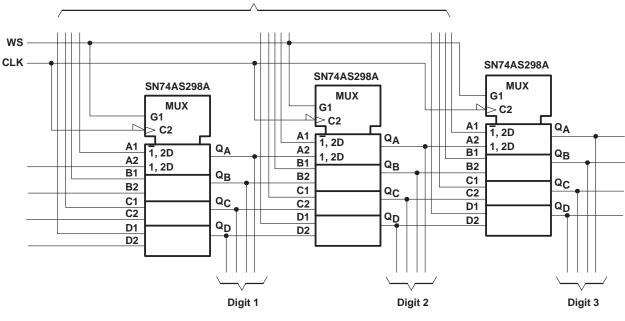


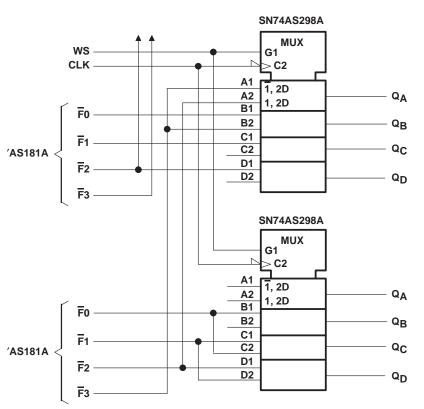
Figure 1. BCD Shift Register

When WS is high and the registers are clocked, the content of register 1 is transferred (shifted) to register 2, etc., effectively shifting the BCD digits one position. This application also retains a parallel-load capability, which means that new BCD data can be entered into the entire register with one clock pulse. This arrangement can be modified to perform the shifting of binary data for any number of bit locations.

Another function that can be implemented is a register designed specifically for supporting multiplier or division operations (see Figure 2).

When WS is low and the register is clocked, the outputs of the arithmetic/logic units (ALUs) are shifted one place. When WS is high and the registers are clocked, the data is shifted two places.





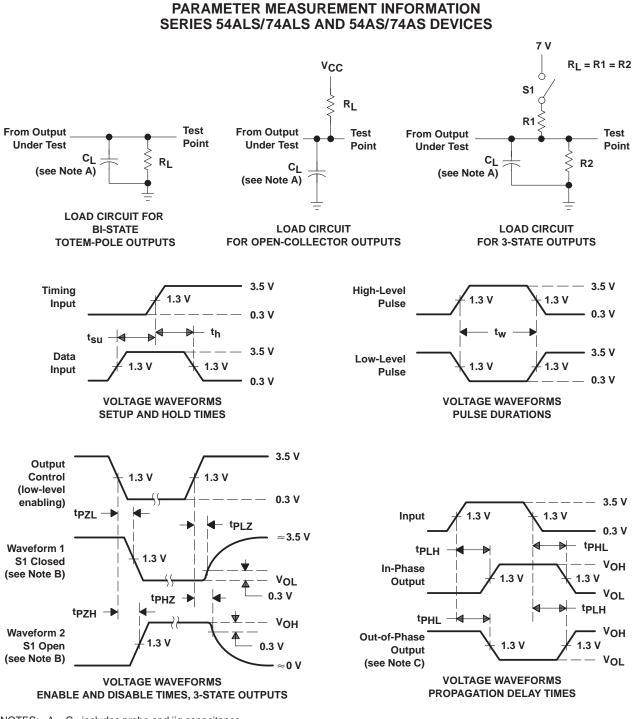
APPLICATION INFORMATION

Figure 2. 1-Place/2-Place Shift Register



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_f = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.
 - Figure 3. Load Circuits and Voltage Waveforms



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